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February 2015

FSA2567 — Low-Power, Dual SIM Card Analog Switch

Features

- Low On Capacitance for Data Path: 10 pF Typical
- Low On Resistance for Data Path: 6 Ω Typical
- Low On Resistance for Supply Path: 0.4 Ω Typical
- Wide V_{CC} Operating Range: 1.65 V to 4.3 V
- Low Power Consumption: 1 μA Maximum
 - 15 μA Maximum I_{CCT} Over Expanded Voltage Range (V_{IN}=1.8 V, V_{CC}=4.3 V)
- Wide -3 db Bandwidth: > 160 MHz
- Packaged in:
 - Pb-free 16-Lead MLP & 16-Lead UMLP
- 3 kV ESD Rating, >12 kV Power/GND ESD Rating

Applications

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

Description

The FSA2567 is a bi-directional, low-power, dual double-pole, double-throw (4PDT) analog switch targeted at dual SIM card multiplexing. It is optimized for switching the WLAN-SIM data and control signals and dedicates one channel as a supply-source switch.

The FSA2567 is compatible with the requirements of SIM cards and features a low on capacitance (C_{ON}) of 10 pF to ensure high-speed data transfer. The V_{SIM} switch path has a low R_{ON} characteristic to ensure minimal voltage drop in the dual SIM card supply paths.

The FSA2567 contains special circuitry that minimizes current consumption when the control voltage applied to the SEL pin is lower than the supply voltage (V_{CC}). This feature is especially valuable in ultra-portable applications, such as cell phones; allowing direct interface with the general-purpose I/Os of the baseband processor. Other applications include switching and connector sharing in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

Ordering Information

| Part Number | Top Mark | Operating Temperature Range | Package |
|-------------|----------|-----------------------------------|--|
| FSA2567MPX | FSA2567 | -40 to +85°C | 16-Lead, Molded Leadless Package (MLP) Quad, JEDEC MO-220, 3 mm Square |
| FSA2567UMX | GX | | 16-Lead, Quad, Ultrathin Molded Leadless Package (UMLP), 1.8 x 2.6 mm |

For Fairchild's definition of Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs_green.html.

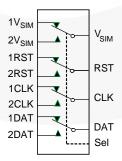


Figure 1. Analog Symbol

Pin Assignments

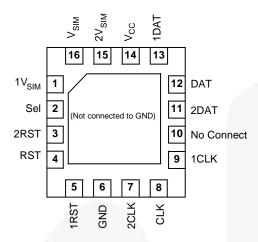


Figure 2. Pad Assignment MLP16 (Top Through View)

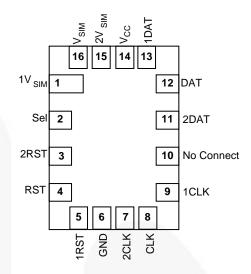


Figure 3. Pad Assignment UMLP16 (Top Through View)

Pin Definitions

| Pin | Description |
|----------------------------------|--------------------------------|
| nDAT, nRST, nCLK | Multiplexed Data Source Inputs |
| nV _{SIM} | Multiplexed SIM Supply Inputs |
| V _{SIM} , DAT, RST, CLK | Common SIM Ports |
| Sel | Switch Select |

Truth Table

| Sel | Function | | |
|------------|--|--|--|
| Logic LOW | 1DAT = DAT, 1RST = RST, 1CLK = CLK, 1V _{SIM} = V _{SIM} | | |
| Logic HIGH | 2DAT = DAT, 2RST = RST, 2CLK = CLK, 2V _{SIM} = V _{SIM} | | |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Min. | Max. | Unit | |
|--------------------|--|------------|------|-----------------------|----|
| V _{CC} | Supply Voltage | -0.5 | +5.5 | V | |
| V _{CNTRL} | DC Input Voltage (Sel) ⁽¹⁾ | | -0.5 | Vcc | V |
| V_{SW} | DC Switch I/O Voltage ⁽¹⁾ | | -0.5 | V _{CC} + 0.3 | V |
| I _{IK} | DC Input Diode Current | | -50 | | mA |
| I _{SIM} | DC Output Current - V _{SIM} | | | 350 | mA |
| I _{OUT} | DC Output Current - DAT, CLK, RST | | 35 | mA | |
| T _{STG} | Storage Temperature | -65 | +150 | °C | |
| 7 | Human Body Model, JEDEC: JESD22-A114 | All Pins | 1 | 3 | |
| ESD | Truman Body Wodel, JEDEC. JESD22-ATT4 | I/O to GND | | 12 | kV |
| | Charged Device Model, JEDEC: JESD22-C101 | | | 2 | |

Note:

 The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | | Max. | Unit |
|--------------------|--|------|-----------------|------|
| V _{CC} | Supply Voltage | 1.65 | 4.30 | V |
| V _{CNTRL} | Control Input Voltage (Sel) ⁽²⁾ | 0 | V _{cc} | V |
| Vsw | Switch I/O Voltage | -0.5 | Vcc | V |
| I _{SIM} | DC Output Current - V _{SIM} | / | 150 | mA |
| l _{OUT} | DC Output Current – DAT, CLK, RST | | 25 | mA |
| T _A | Operating Temperature | -40 | +85 | °C |

Note:

2. The control input must be held HIGH or LOW; it must not float.

DC Electrical Characteristics

All typical values are at 25°C, 3.3 V V_{CC} unless otherwise specified.

| Symbol | Danamatan | O a malistia ma | V _{cc} (V) | T _A =- 40°C to +85°C | | | 11 |
|---|---|---|---------------------------|---------------------------------|------|------|-------|
| | Parameter | Conditions | | Min. | Тур. | Max. | Units |
| V _{IK} | Clamp Diode Voltage | I _{IN} = -18 mA | 2.7 | | | -1.2 | V |
| | | | 1.65 to 2.3 2.7 to 3.6 | 1.1 | | | V |
| V_{IH} | Input Voltage High | | | 1.3 | | | |
| | | | 4.3 | 1.7 | | | |
| | | | 1.65 to 2.3 | | | 0.4 | |
| V_{IL} | Input Voltage Low | | 2.7 to 3.6 | | | 0.5 | V |
| | | | 4.3 | | | 0.7 | |
| I _{IN} | Control Input Leakage | $V_{SW} = 0$ to V_{CC} | 4.3 | -1 | | 1 | μA |
| I _{nc(off),} I _{no(off),} | Off State Leakage | nRST, nDAT, nCLK, $nV_{SIM} = 0.3 V$ or 3.6 V Figure 10 | 4.3 | -60 | | 60 | nA |
| D | Data Path Switch On | V _{SW} = 0, 1.8 V, I _{ON} = -20 mA Figure 9 | 1.8 | | 7.0 | 12.0 | |
| R _{OND} | Resistance ⁽³⁾ | V _{SW} = 0, 2.3 V, I _{ON} = -20 mA Figure 9 | 2.7 | | 6.0 | 10.0 | Ω |
| D | V _{SIM} Switch | V _{SW} = 0, 1.8V, I _{ON} = -100mA Figure 9 | 1.8 | | 0.5 | 0.7 | |
| R_{ONV} | On Resistance ⁽³⁾ | V _{SW} = 0, 2.3 V, I _{ON} = -100 mA Figure 9 | 2.7 | | 0.4 | 0.6 | Ω |
| ΔR_{OND} | Data Path Delta On Resistance ⁽⁴⁾ | V _{SW} = 0 V, I _{ON} = -20 mA | 2.7 | | 0.2 | | Ω |
| Icc | Quiescent Supply Current | V _{CNTRL} = 0 or V _{CC} , I _{OUT} = 0 | 4.3 | | _ | 1.0 | μA |
| ķi. | Increase in I _{CC} | $V_{CNTRL} = 2.6 \text{ V}, V_{CC} = 4.3 \text{ V}$ | 4.3 | | 5.0 | 10.0 | μA |
| Ісст | Current Per Control Voltage and V _{CC} | V _{CNTRL} = 1.8 V, V _{CC} = 4.3 V | 4.3 | | 7.0 | 15.0 | μA |

Notes:

- 3. Measured by the voltage drop between nDAT, nRST, nCLK and relative common port pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the relative ports.
- 4. Guaranteed by characterization.

AC Electrical Characteristics

All typical value are for V_{CC} =3.3V at 25°C unless otherwise specified.

| Cumbal | Parameter | Canditions | V _{cc} (V) | T _A =- 40°C to +85°C | | | Units |
|-------------------|--|--|---------------------|---------------------------------|------|------|--------|
| Symbol | | Conditions | | Min. | Тур. | Max. | Uiilla |
| t _{OND} | Turn-On Time Sel to Output | $R_L = 50 \Omega, C_L = 35 pF$ $V_{SW} = 1.5 V$ | 1.8 ⁽⁵⁾ | | 65 | 95 | ns |
| OND | (DAT,CLK,RST) | Figure 11, Figure 12 | 2.7 to 3.6 | | 42 | 60 | ns |
| t _{OFFD} | Turn-Off Time Sel to Output | $R_L = 50 \Omega, C_L = 35 pF$ $V_{SW} = 1.5 V$ | 1.8 ⁽⁵⁾ | | 30 | 50 | ns |
| 4011 D | (DAT,CLK,RST) | Figure 11, Figure 12 | 2.7 to 3.6 | | 20 | 40 | ns |
| t _{ONV} | Turn-On Time | $R_L = 50 \Omega, C_L = 35 pF$ $V_{SW} = 1.5 V$ | 1.8 ⁽⁵⁾ | | 55 | 80 | ns |
| ONV | Sel to Output (V _{SIM}) | Figure 11, Figure 12 | 2.7 to 3.6 | | 35 | 55 | ns |
| t _{OFFV} | Turn-Off Time Sel to Output (V _{SIM}) | $R_L = 50 \Omega, C_L = 35 pF$ $V_{SW} = 1.5 V$ | 1.8 ⁽⁵⁾ | | 35 | 50 | |
| COFFV | | Figure 11, Figure 12 | 2.7 to 3.6 | | 22 | 40 | ns |
| t _{PD} | Propagation Delay ⁽⁵⁾ (DAT,CLK,RST) | C_L = 35 pF, R_L = 50 Ω Figure 11, Figure 13 | 3.3 | | 0.25 | | ns |
| t _{BBMD} | Break-Before-Make ⁽⁵⁾ (DAT,CLK,RST) | $R_L = 50 \ \Omega, \ C_L = 35 \ pF$ $V_{SW1} = V_{SW2} = 1.5 \ V$ Figure 15 | 2.7 to 3.6 | 3 | 18 | | ns |
| t _{BBMV} | Break-Before-Make ⁽⁵⁾ | $R_L = 50 \ \Omega, \ C_L = 35 \ pF$ $V_{SW1} = V_{SW2} = 1.5 \ V$ Figure 15 | 2.7 to 3.6 | 3 | 12 | | ns |
| Q | Charge Injection (DAT,CLK,RST) | $\begin{split} C_{L} = 50 \text{ pF, } R_{GEN} = 0 \Omega, \\ V_{GEN} = 0 V \end{split}$ | 2.7 to 3.6 | | 10 | | pC |
| O _{IRR} | Off Isolation (DAT,CLK,RST) | $R_L = 50 \Omega$, $f = 10 MHz$ Figure 17 | 2.7 to 3.6 | | -60 | | dB |
| Xtalk | Non-Adjacent Channel Crosstalk (DAT,CLK,RST) | $R_L = 50 \Omega$, $f = 10 MHz$ Figure 18 | 2.7 to 3.6 | | -60 | | dB |
| BW | -3 db Bandwidth (DAT,CLK,RST) | $R_L = 50 \Omega$, $C_L = 5 pF$ Figure 16 | 2.7 to 3.6 | | 475 | | MHz |

Note:

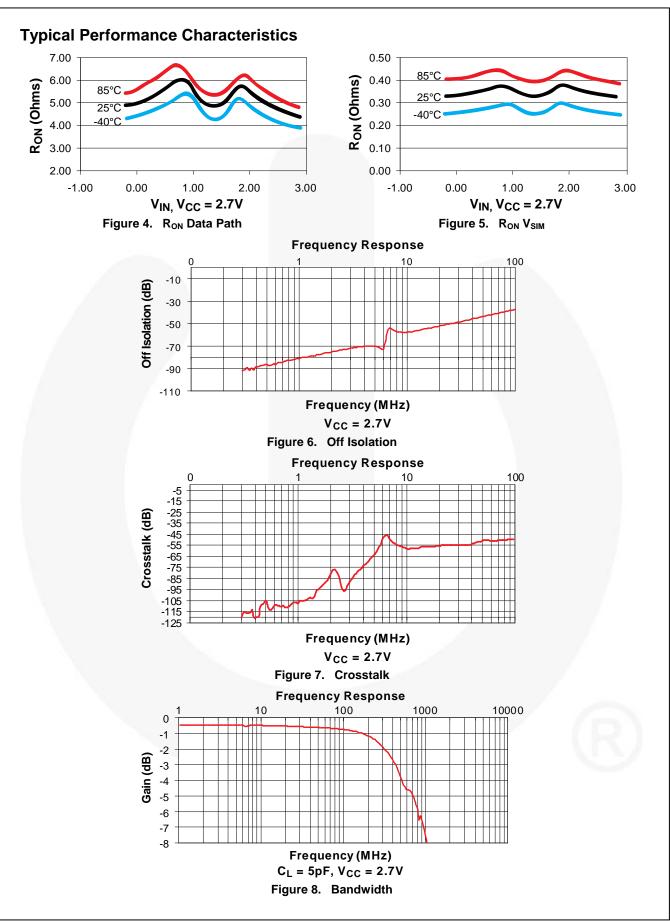
5. Guaranteed by characterization.

Capacitance

| Symbol | Doromotor | Conditions | T _A =- 40°C to +85°C | | | Units |
|-------------------|--|---|---------------------------------|------|------|--------|
| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Ullits |
| C _{IN} | Control Pin Input Capacitance | V _{CC} = 0 V | | 1.5 | | |
| C _{OND} | RST, CLK, DAT On Capacitance ⁽⁶⁾ | V _{CC} = 3.3 V, f = 1 MHz Figure 20 | | 10 | 12 | |
| C _{ONV} | V _{SIM} On Capacitance ⁽⁶⁾ | V _{CC} = 3.3 V, f = 1 MHz Figure 20 | | 110 | 150 | pF |
| C _{OFFD} | RST, CLK, DAT Off Capacitance | V _{CC} = 3.3 V, Figure 19 | | 3 | | |
| C_{OFFV} | V _{SIM} Off Capacitance | V _{CC} = 3.3 V, Figure 19 | | 40 | | |

Note:

6. Guaranteed by characterization.



Test Diagrams

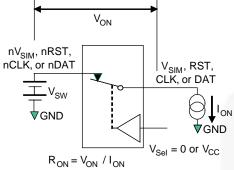
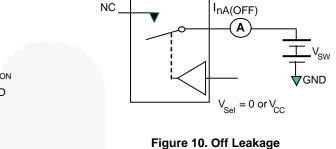
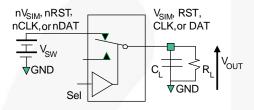


Figure 9. On Resistance





 ${
m R_L}$ and ${
m C_L}$ are functions of the application environment (see tables for specific values). ${
m C_L}$ includes test fixture and stray capacitance.

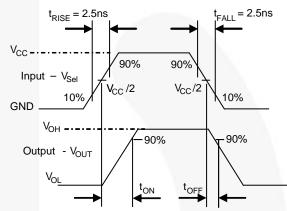


Figure 12. Turn-On / Turn-Off Waveforms

Figure 11. AC Test Circuit Load

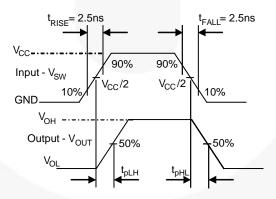


Figure 13. Propagation Delay

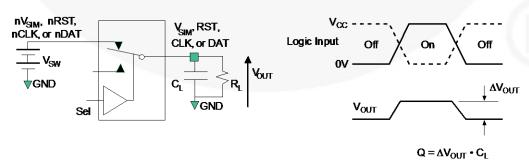
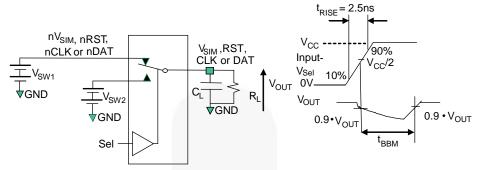


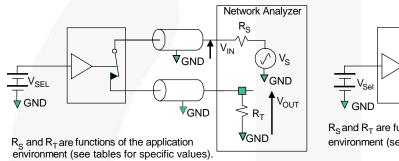
Figure 14. Charge Injection

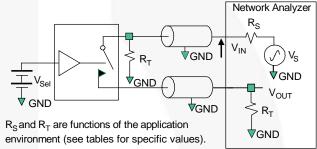
Test Diagrams (Continued)



 R_L and C_L are functions of the application environment (see tables for specific values). C_L includes test fixture and stray capacitance.

Figure 15. Break-Before-Make Interval Timing





Off isolation = 20 Log (V_{OUT} / V_{IN})

Figure 16. Bandwidth

Figure 17. Channel Off Isolation

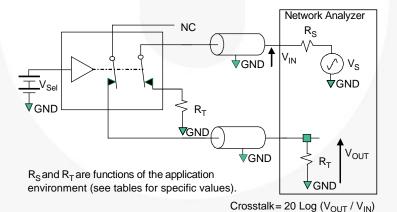


Figure 18. Non-Adjacent Channel-to-Channel Crosstalk

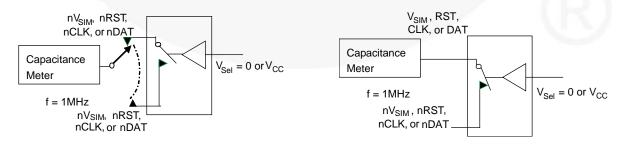
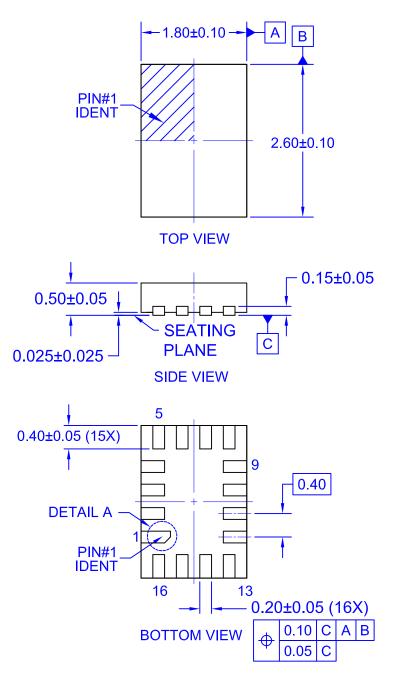
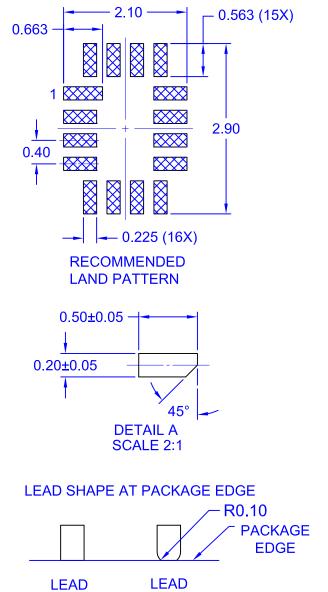


Figure 19. Channel Off Capacitance

Figure 20. Channel On Capacitance





OPTION 2

SCALE 2:1

NOTES:

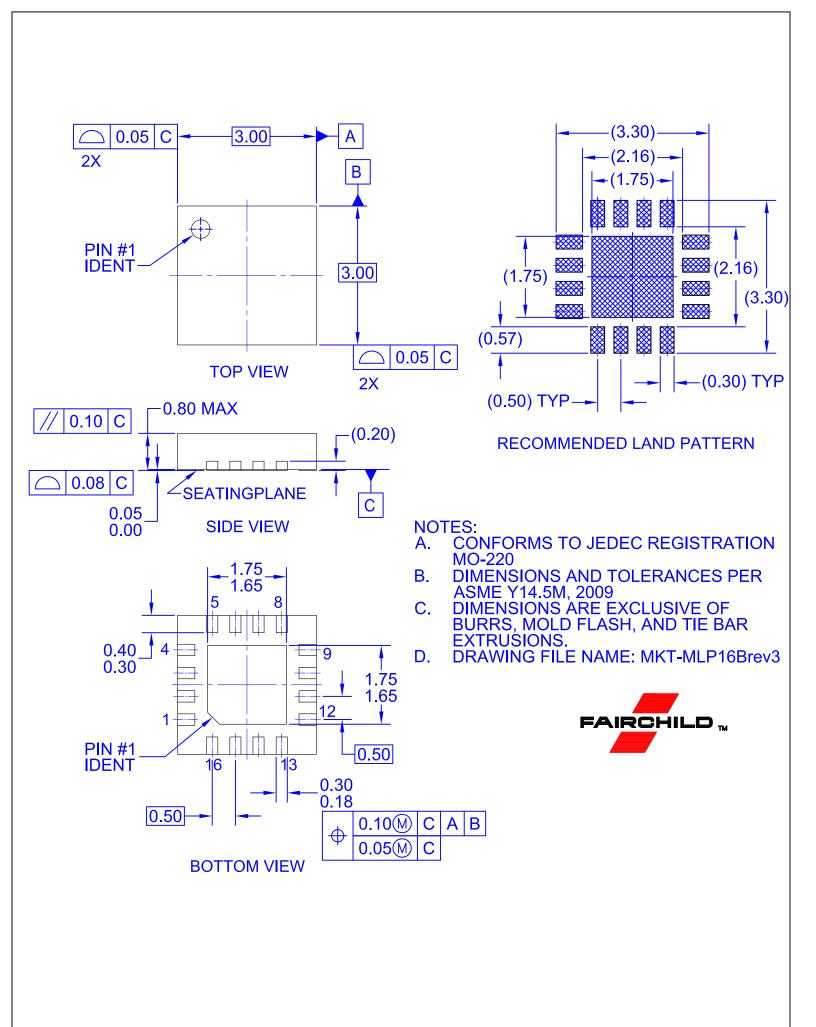
- A. PACKAGE DOES NOT FULLY CONFORM TO JEDEC STANDARD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- D DRAWING FILENAME: MKT-UMLP16ArevG.
- E. TERMINAL SHAPE MAY VARY ACCORDING TO PACKAGE SUPPLIER, SEE TERMINAL SHAPE VARIANTS.

ON Semiconductor

OPTION 1

SCALE 2:1





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